1. QUARTZ CRYSTAL UNIT SPECIFICATION

Parameter	Sign	Specification
1.1 Nominal Frequency :	F0	8.000MHz
1.2 Holder type :	-	FTX321S (SMD3225 SEAM TYPE)
1.3 Mode of oscillation :	-	Fundamental
1.4 Frequency tolerance :	FL	±10ppm at 25 ℃±3℃
1.5 Equivalent resistance :	RR	300 ohms max.
1.6 Operating temperature range :	Topr	-40 ℃ To +85 ℃
1.7 Storage temperature range :	Tstg	-55℃ To +125℃
1.8 Frequency Stability :	тс	±50ppm at -40 ℃ To +85 ℃
1.9 Loading capacitance :	CL	12pF
1.10 Drive level :	DL	10 uW Typical. 200uW Max
1.11 Shunt Capacitance :	C0	3.0pF max.
1.12 Insulation resistance :	IR	More than 500M Ω at DC 100V
1.13 Circuit:	-	Measured in HP/E5100A,S&A 250B
1.14 Aging :	Fa	±2ppm max. (+25°C 1 st Year)
1.15 Dimensions and marking :		Refer to page.3
1.16 Emboss carrier tape & reel :		Refer to page.5 and page.6
1.17 Note :		
Standard atmospheric conditions Unless otherwise specified, the standard	range of atm	ospheric conditions for making measurement

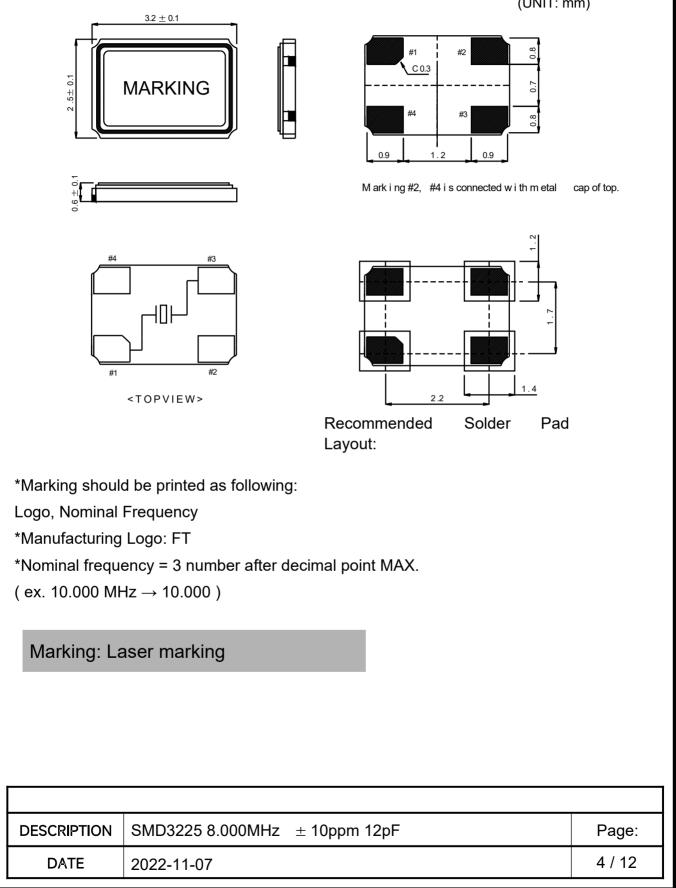
and tests are as follow:

Ambient temperature : 25±3°C Relative humidity : 40%~70%

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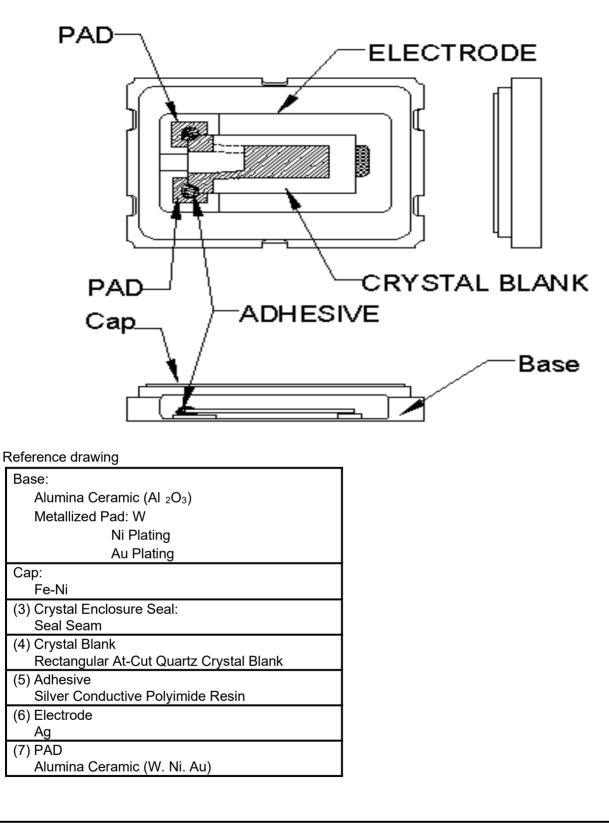
2. FTX321S MARKING & DIMENSIONS

(UNIT: mm)



3. INSIDE STRUCTURE

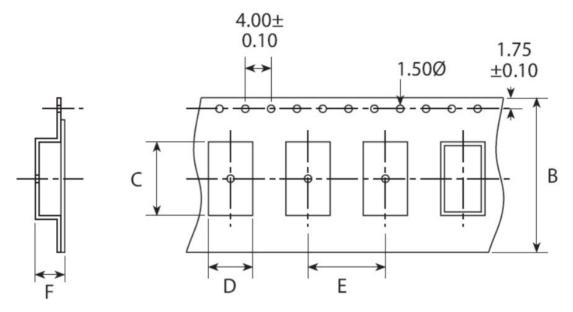
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4. FTX321S EMBOSS CARRIER TAPE & REEL

a.) Dimensions of Carrier Tape

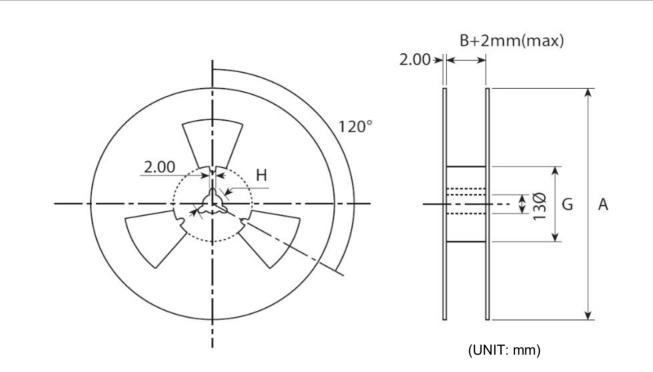


	A	В	С	D	E	F	G
SMD322	178± 2.0	8.0 ± 0.3	3.5 ± 0.1	2.8 ± 0.1	4.0±0.1	1.4± 0.1	60.5 ± 1.0
5							

(UNIT: mm)

b.) Dimensions of Reel

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- c.) Storage condition Temperature: +40deg.C Max. Relative Humidity: 80% Max.
- d.) Standard packing quantity 3,000PCS / REEL
- e.) Material of the tape

Таре	Material
Carrier tape	A – PET
Top tape	Polyester

f.) Label contents

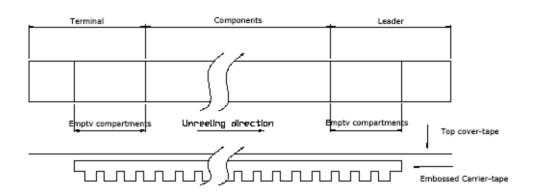
,		
.The type of product		
.Our specification No.	PART NUMBER	
.Your Part No.	PO NO	
.Lot No.	PR. NO:	
.Nominal Frequency	HOLDER TYPE	
.Quantity	FREQUENCY	
.Our Company Name	REMAKS	
	QUANTITY	
Sticks lobal for eveny real		

Sticks label for every reel.

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g.) Taping dimension

Loador	Cover-tape	The length of cover-tape in the leader is more than 400 mm including empty
Leader Carrier-tape		After all products were packaged, must remain more than twenty pieces or
Termina	Cover-tape	The tip of cover-tape shall be fixed temporary by paper tape and roll around
I	Carrier-tape	The empty embossed area which are sealed by top cover-tape must remain

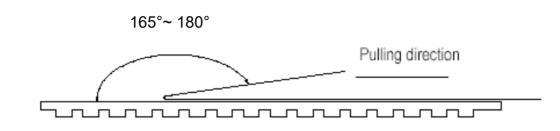


h.) Joint of tape

The carrier-tape and top cover-tape should not be jointed.

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i.) Release strength of cover tape
It has to between 0.1N to 0.7N under following condition.
Pulling direction 165° to 180°
Speed 300mm/min.
Otherwise unless specified.



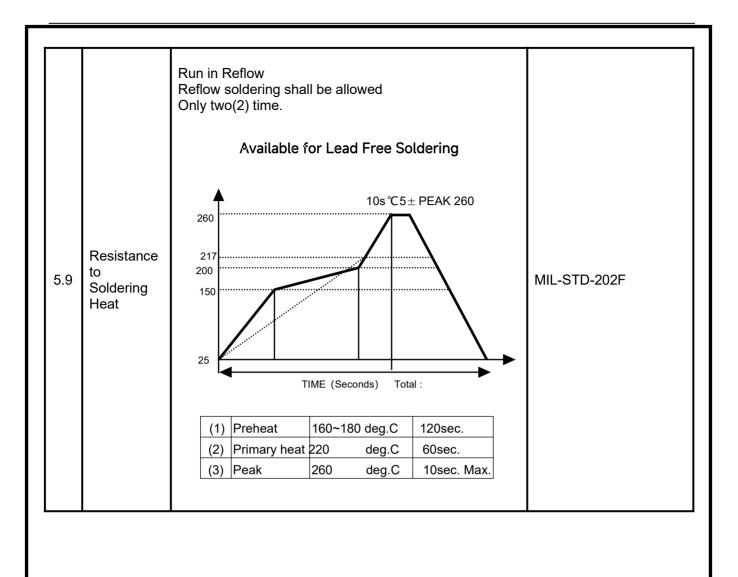
Other standards shall be based on JIS C 0806-1990.

5. Mechanical Endurance: Provided that measurement shall be carried out afterletting it alone in the room temperature for 1 hour.

	ltem	Conditions	Specifications
5.1	Drop	Fall freely from 100 cm of height 3 times on a firm wood	MIL-STD-202F-203B
5.2	Mechanical Shock	Device are shocked to half sine wave (1000 G) three mutually perpendicular axes each 3 times.	MIL-STD-202F
5.3	Vibration	 (1)Vibration Frequency: 10~55Hz (2)Cycle: 1 to 2 Min. (3)Full Cycle: 1.5mm P-P. (4)Direction: X.Y.Z (5)Time: 2 Hours / Each Direction 	MIL-STD-883E
5.4	Substrate Bending	Mount the specimen on substrate. Apply the following pressure Direction: see Fig –1 Speed: 0.5 mm/sec Hours: 5 ± 1 sec Amount of substrate: 3 mm Max.	Without mechanical damage such as breaks. Without electrode peeling. Electrical characteristics
5.5	Adhesion	Mount the specimen on substrate. Apply the following pressure Direction: see Fig –2 Weight: 10N Hours: 10 ± 1 sec	shall be satisfied.

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5.6 Body strength	Weight: 10N Hours: 10 ± 1 sec	
5.7 Seal	Fine Leak: 4.5kgf/cm 22hours 1×109 Pa.m3/secMIL-STEGross Leak: 4.5kgf/cm 22hours 1.5×105 Pa.m3/secMIL-STE	D-883E
Pressure jig R 230	R0.5 PCB 45±2	W Pressure jig specimen
Fig	-1 Fig-2	Fig-3
5.8 Solder ability	Pre-heat temperature : +150±10°CPre-heat time : 60~120sWhen the temperature of the specimen is reached at+215±3°C, it shall be left for 30±1sec.Peak temperature 240±5°CMaterial: Pb-free (Sn-3.0Ag-0.5Cu)Flux : Rosin resin methyl alcohol solvent (1:4)The electrodes should be covered by a new solder atleast 90% of immersed area.	D-883E 2003
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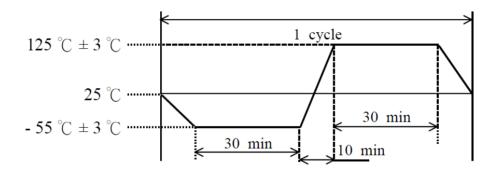


6. Environmental Endurance: Provided that measurement shall be carried out afterletting it alone in the room temperature for 1 hour.

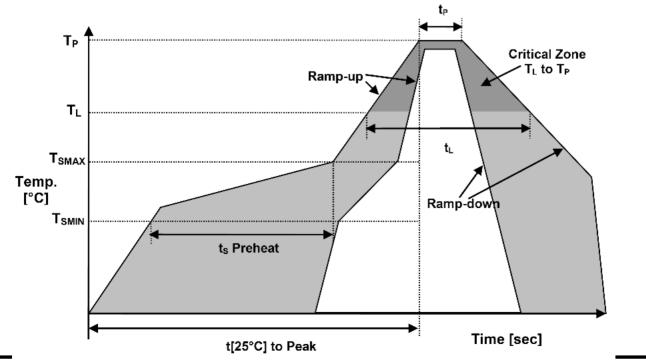
	fications
6.1+60°C±2°C,RH 80~85%, Duration of 500 hours. The units are then allowed to stand for approx 2 hours in room temperature before checkingMIL-STD-2	202F

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6.2	Storage in Low Temperature	Temperature: -40±2°C , Duration of 500 hours. The units are then allowed to stand at room temperature for approx 2 hours before checking.	MIL-STD-883E
6.3	Storage in High Temperature	Temperature:+85°C±2°C, Duration of 500 hours. The units are then allowed to stand at room temperature for approx 2 hours before checking.	MIL-STD-883E
6.4	Thermal Shock	Temperature 1: -55°C±5°C Temperature 2: 125°C±5°C Temperature change between T1 and T2 at soonest Run 100 cycles, maintain T1 and T2 30minutes each in one cycle (Refer to Fig-4)	MIL-STD-883E



7. Recommended Solder Reflow Profile



Temperature Min Preheat	TSMIN	150°C
Temperature Max Preheat	TSMAX	175℃
Time (T _{SMIN} to T _{SMAX})	ts	60-180 sec.
Temperature	TL	217°C
Peak Temperature	TP	260°C
Ramp-up rate	RUP	3°C/sec max.
Ramp-down rate	RDOWN	6°C/sec max.
Time within 5°C of Peak Temperature	tP	10 sec max.
Time t[25°C] to Peak Temperature	t[25°C] to Peak	480 sec max.
Time	t∟	60-150 sec.

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